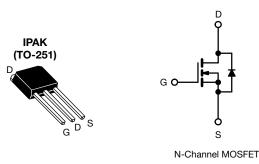
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	1.25			
Q _g max. (nC)	16.5				
Q _{gs} (nC)	3				
Q _{gd} (nC)	5				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
 - Induction heating
 - Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	IPAK (TO-251)
Lead (Pb)-free and halogen-free	SiHU4N80AE-GE3

ABSOLUTE MAXIMUM RATINGS (T _C						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	v	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T_J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D -	4.1		
	VGS at 10 V	T _C = 100 °C		2.6	А	
Pulsed drain current ^a			I _{DM}	7.0		
Linear derating factor				0.5	W/°C	
Single pulse avalanche energy ^b			E _{AS}	6.9	mJ	
Maximum power dissipation			PD	62.5	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		T _J = 125 °C	70			
Reverse diode dv/dt ^d		dv/dt	0.2	V/ns		
Soldering recommendations (peak temperature) ^c		For 10 s		260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 0.7 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt = 100 \; A/\mu s, \, starting \; T_J = 25 \; ^\circ C$

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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP. MAX.			UNIT				
Maximum junction-to-ambient	R _{thJA}	- 62			°C/W				
Maximum junction-to-case (drain)	R _{thJC}	- 2.0				-0/10			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	800	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	2.0	-	4.0	V	
		V _{GS} = ± 20 V			-	-	± 100	nA	
Gate-source leakage	I _{GSS}	V _{GS} = ± 30 V			-	-	± 10	μA	
Zara acta valtaga duain avumant	V _{DS} = 80	800 V, V _G	_S = 0 V -		-	1	•		
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 1.0 A	-	1.25	1.44	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D	= 2 A	-	1.1	-	S	
Dynamic					•	•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	11	-	pF		
Output capacitance	C _{oss}			-	3	-			
Reverse transfer capacitance	C _{rss}			-	5	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	10	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	65	-			
Total gate charge	Qg				-	11	16.5		
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 2 A, V		, V _{DS} = 640 V	-	3	-	nC	
Gate-drain charge	Q _{gd}				-	5	-		
Turn-on delay time	t _{d(on)}	V_{DD} = 640 V, I _D = 2 A, V _{GS} = 10 V, R _g = 4.7 Ω f = 1 MHz, open drain		-	11	22	- ns		
Rise time	t _r			-	7	14			
Turn-off delay time	t _{d(off)}			-	12	24			
Fall time	t _f			-	25	50			
Gate input resistance	Rg			1.7	3.5	7.0	Ω		
Drain-Source Body Diode Characteristi		•							
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.0	A		
Pulsed diode forward current	I _{SM}			-	-	7.0			
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 2 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 2 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	266	532	ns		
Reverse recovery charge	Q _{rr}			-	1.1	2.2	μC		
Reverse recovery current	I _{RRM}			-	6.6	-	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

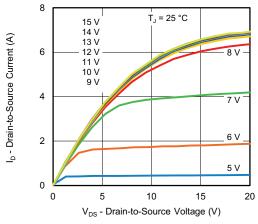


Fig. 1 - Typical Output Characteristics

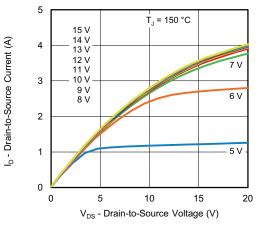


Fig. 2 - Typical Output Characteristics

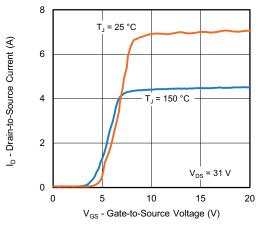


Fig. 3 - Typical Transfer Characteristics

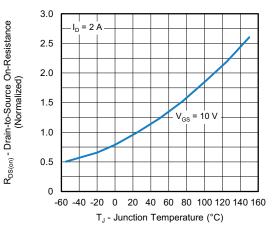


Fig. 4 - Normalized On-Resistance vs. Temperature

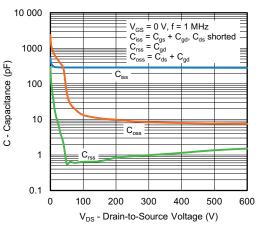


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

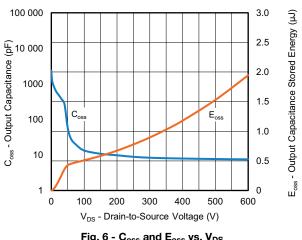


Fig. 6 - Coss and Eoss vs. VDS

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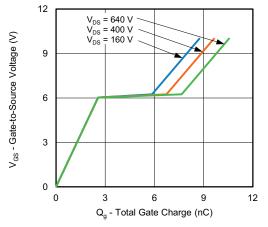


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

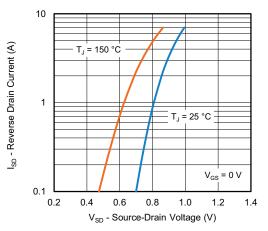


Fig. 8 - Typical Source-Drain Diode Forward Voltage

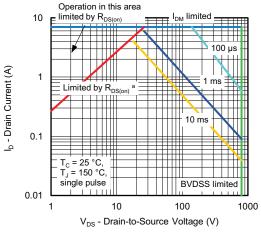


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

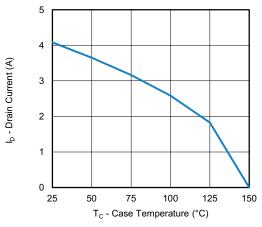


Fig. 10 - Maximum Drain Current vs. Case Temperature

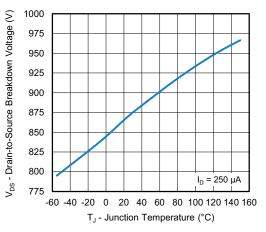


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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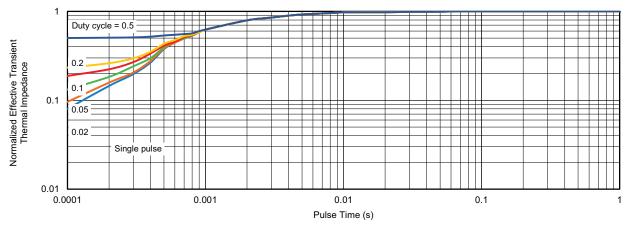


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

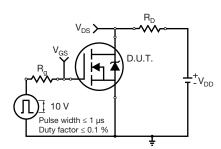


Fig. 13 - Switching Time Test Circuit

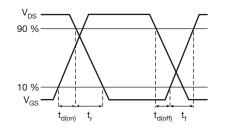


Fig. 14 - Switching Time Waveforms

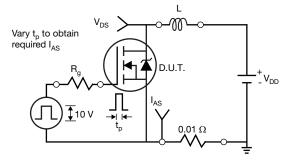


Fig. 15 - Unclamped Inductive Test Circuit

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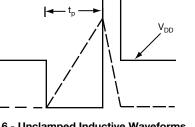


Fig. 16 - Unclamped Inductive Waveforms

V_{DS}

 I_{AS}

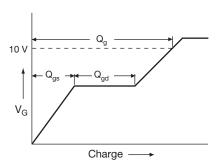
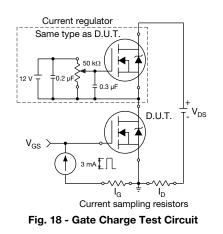


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

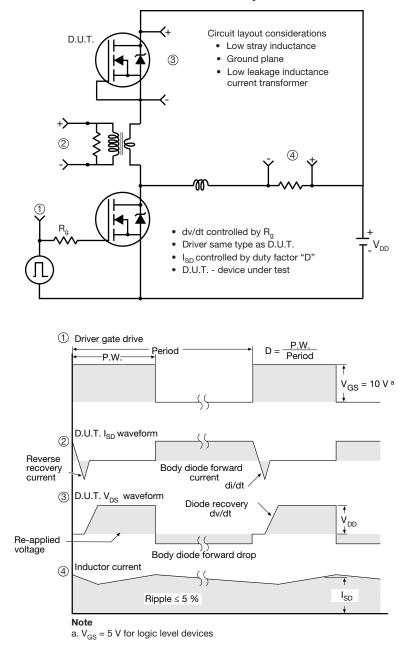


Fig. 19 - For N-Channel

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